

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Dong Zhang</td> <td>04/11/2012</td> </tr> <tr> <td>Sang Sool Koo</td> <td>03/08/2012</td> </tr> </tbody> </table>		Name	Execution Date	Dong Zhang	04/11/2012	Sang Sool Koo	03/08/2012				
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>X-FAB Semiconductor Foundries AG</td> </tr> <tr> <td>Street Address:</td> <td>Haarbergstrasse 67</td> </tr> <tr> <td>City:</td> <td>Erfurt</td> </tr> <tr> <td>State/Country:</td> <td>GERMANY</td> </tr> <tr> <td>Postal Code:</td> <td>99097</td> </tr> </table>		Name:	X-FAB Semiconductor Foundries AG	Street Address:	Haarbergstrasse 67	City:	Erfurt	State/Country:	GERMANY	Postal Code:	99097
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13389888</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13389888						
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CORRESPONDENCE DATA											
<p>Fax Number: (937)443-6635 Phone: 937-443-6600 Email: ipdocket@thompsonhine.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Steven J. Elleman, Esq. Address Line 1: 10050 Innovation Drive Address Line 2: Suite 400 Address Line 4: DAYTON, OHIO 45342-4934</p>											
ATTORNEY DOCKET NUMBER:	534334-00106US/AMI										
NAME OF SUBMITTER:	Steven J. Elleman										
Total Attachments: 2 source=534664-00106US_ASSIGNMENT#page1.tif source=534664-00106US_ASSIGNMENT#page2.tif											

OP \$40.00 13389888

Application No. 13/389,888

Filed: 10 February 2012

ASSIGNMENT

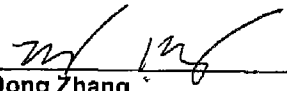
WHEREAS, **Dong (no middle Name) Zhang** of Shanghai, China, and **Sang Sool Koo** of Sarawak, Malaysia, invented a certain new and useful METHOD OF MANUFACTURING AN ORGANIC LIGHT EMITTING DIODE BY LIFT-OFF (Docket No. 534334-00106US) for which I/we executed an application for letters patent of the United States;

AND WHEREAS, **X-FAB Semiconductor Foundries AG**, a corporation of Germany, with a place of business at **Haarbergstrasse 67, Erfurt, 99097, Germany**, hereinafter called the Assignee, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any letters patent that may issue thereon;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable consideration, receipt whereof is hereby acknowledged, I/we hereby sell, assign and transfer unto said Assignee, its successors and assigns, the entire right, title and interest in and to said application, any application claiming priority therefrom, any non-provisionals, divisions or continuations thereof, and the inventions therein disclosed, and any improvements thereon, and any patent or patents that may be issued or reissued thereon, and I/we hereby authorize and request the Commissioner of Patents and Trademarks to issue any letters patent thereon, and reissues thereof, to said Assignee, its successors and assigns; and I/we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and I/we hereby agree that, upon request, I/we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

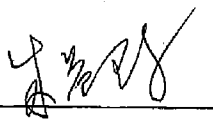
The undersigned hereby grants Steven J. Elleman, Registration No. 41,733, of Thompson Hine, LLP, 10 W. Second Street, 2000 Courthouse Plaza, NE, Dayton, Ohio 45402-1758, power to insert in this assignment any further identification that may be necessary or desirable in order to aid in the recordation of this document.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 11th day of April, 2012.


Dong Zhang

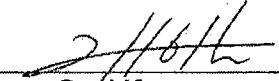
Witness:

Name:



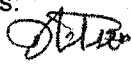
Application No. 13/389,888
Docket No. 534334-00106US
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Page 2

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 8 day of
March, 2011.



Sang Sool Koo

Witness:



Name: David Kho Ching Tien

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